

SinglFuse[™] SF-2410HI-T Series Features

- Single blow fuse for overcurrent protection
- EIA 2410 (6125 metric) footprint
- Ceramic tube design for high inrush fusing speed applications
- UL 248-14 listed
- Surface mount packaging for automated assembly
- RoHS compliant* and halogen free**

SF-2410HI-T Series – High Inrush SMD Fuses

Electrical Characteristics

Model	Rated Current (A)	Fusing Time	Resistance (Ω) Typ.***	Rated Voltage	Interrupting Rating	Typical l²t (A²s) ****	Certifications
							cUL
							E198545
SF-2410HI0375T-2	0.375	Open within 1-60 sec. at 200 % rated current	0.6208			0.4147	✓
SF-2410HI050T-2	0.5		0.3462			0.495	✓
SF-2410HI075T-2	0.75		0.1666			1.2632	✓
SF-2410HI100T-2	1		0.1079			1.9933	✓
SF-2410HI150T-2	1.5		0.057	125 VAC	50 A @ 125 VAC 50 A @ 125 VDC 300 A @ 32 VDC	2.82	√
SF-2410HI200T-2	2		0.0509			7.488	√
SF-2410HI250T-2	2.5		0.0317			16.771	✓
SF-2410HI300T-2	3		0.0228			24.99	✓
SF-2410HI350T-2	3.5		0.0196			24.908	√
SF-2410HI400T-2	4		0.015			27.056	√
SF-2410HI500T-2	5		0.0112			50.308	✓
SF-2410HI700T-2	7		0.0083			100.06	✓

Resistance value measured with ≤10 % rated current at 25 °C ambient. Tolerance ±30 %.

^{****} Melting I2t calculated at 10 times rated current.

Environmental Characteristics	
Operating Temperature	55 °C to +125 °C
Storage Conditions	
Temperature	+15 °C to +30 °C
Humidity	20 % to 70 %
Shelf Life	2 years from manufacturing date
Moisture Sensitivity Level	1
ESD Classification (HBM)	Class 6

Agency Recognition

UL File Number E198545



WARNING Cancer and Reproductive Harm

www.P65Warnings.ca.gov

RoHS Directive 2015/863. Mar 31, 2015 and Annex.

Bourns considers a product to be "halogen free" if (a) the Bromine (Br) content is 900 ppm or less; (b) the Chlorine (Cl) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (CI) content is 1500 ppm or less.

SinglFuse™ SF-2410HI-T Series Applications

- Notebooks
- LCD Monitors
- LCD Backlight Inverters
- P0E, P0E+

- PC Servers
- Power Supplies
- Battery Protection
- White Goods

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BOURNS

Reliability Testing

No.	Test	Test Condition	Requirement	Test Reference
1	Solderability	Temperature setup: 235 ±5 °C Time setup: 10 ±1 sec.	After test terminal electrode wetting area must be greater than 95 %	IEC 60068-2-58
2	Resistance to soldering heat	Temperature setup: 235 ±5 °C Time setup: 30 ± 5 sec.	DCR change ≤ ±15 %	IEC 60068-2-58
3	Thermal shock	Temperature setup: $25 ^{\circ}\text{C} \sim -65 ^{\circ}\text{C} \sim 25 ^{\circ}\text{C} \sim 125 ^{\circ}\text{C}$ Time setup: $-65 ^{\circ}\text{C} (30 \text{min})$ $\sim 25 ^{\circ}\text{C} (5 \text{min}) \sim 125 ^{\circ}\text{C} (30 \text{min})$ $\sim 25 ^{\circ}\text{C} (5 \text{min}), 5 \text{cycles}$	DCR change ≤ ±15 % No mechanical damage	MIL-STD-202G Method 107G Test Condition B
4	Humidity unload	Heat (85 ±0.5 °C) High Humidity (85 ±1 % RH) 240 hours	DCR change ≤ ±15 % No mechanical damage	MIL-STD-202G Method 103B Test Condition A
5	Salt spray	Salt spray concentration: 5 ±1 % Test liquid temperature: 35 ±0.5 °C 96 hours	DCR change ≤ ±15 % No mechanical damage	MIL-STD-202G Method 101E Test Condition A
6	Bending	The board shall be bent by 1 mm at a rate of 1 mm/sec.	DCR change ≤ ±15 %	IEC 60127-4
7	Vibration	Frequency setup: 10 ~ 55 ~ 10 Hz Time setup: 1 Minute/cycle (X-Y-Z, 120 cycles, 6 hours)	DCR change ≤ ±15 % No mechanical damage	MIL-STD-202G Method 201A

Typical Part Marking

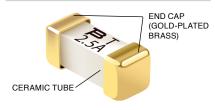
Represents total content. Layout may vary.



Rated Current	Part Marking	
375 mA	375 mA	
500 mA	500 mA	
750 mA	750 mA	
1 A	1 A	
1.5 A	1.5 A	
2 A	2 A	
2.5 A	2.5 A	
3 A	3 A	
3.5 A	3.5 A	
4 A	4 A	
5 A	5 A	
7 A	7 A	

SF - 2410 HI 0375 T - 2 SinglFuse™ Product Designator SMD Footprint 2410 = EIA 2410 (6125 metric) Fuse Blow Type HI = High inrush Rated Current 0375 ~ 700 (375 mA ~ 7 A) Structure Type T = Ceramic Tube Packaging Type - 2 = Tape & Reel

Construction



Packaging Quantity

1,000 pieces per 7-inch reel